

FFPF20U60S

Features

- High voltage and high reliability
- High speed switching
- · Low forward voltage

Applications

- General purpose
- Switching mode power supply



	ode power supply ng diode for motor application 1 2 hing circuits	J. Cathode	2. Anode
II TRA I	FAST RECOVERY POWER RECTIFIE	1. Cathode	
		.11	
bsolute	Maximum Ratings T _C =25°C unless otherwise noted Parameter	Value	Units
Absolute Symbol	Maximum Ratings T _C =25°C unless otherwise noted	1	Units V
Symbol V _{RRM}	Maximum Ratings T _C =25°C unless otherwise noted	Value	
Absolute	Maximum Ratings T _C =25°C unless otherwise noted Parameter Peak Repetitive Reverse Voltage	Value 600	V

Thermal Characteristics

Symbol	Parameter	Value	Units	
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	1.25	°C/W	

Electrical Characteristics τ_{C} =25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V _{FM} *	Maximum Instantaneous Forward Voltage					V
	I _F = 20A	$T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$			2.2	
	I _F = 20A	1 _C = 100 °C			2.0	
I _{RM} *	Maximum Instantaneous Reverse Current @ rated V _R	T _C = 25 °C T _C = 100 °C			10 100	μΑ
t _{rr} I _{rr} Q _{rr}	Maximum Reverse Recovery Time Maximum Reverse Recovery Current Maximum Reverse Recovery Charge (I _F =20A, di/dt = 200A/μs)				90 8 360	ns A nC
W_{AVL}	Avalanche Energy		1.0			mJ

* Pulse Test: Pulse Width=300µs, Duty Cycle=2%

Typical Characteristics Reverse Current , I _R [μΑ] T_C = 100°C Forward Current , I_F[A] $T_{c} = 100^{\circ}C$ 10 0.1 0.01 0.1 - 0.0 1E-3 100 0.5 1.5 Forward Voltage , V_F [V] Reverse Voltage , $V_{_{\rm R}}[V]$ Figure 1. Typical Forward Voltage Drop Figure 2. Typical Reverse Current vs. Forward Current vs. Reverse Voltage 200 Typical Capacitance I_F = 20A at 0V = 178 pF $T_C = 25^{\circ}C$ Reverse Recovery Time, t. Capacitance, Cj [pF] 60 50 40 L 100 0.1 500 di/dt [A/μs] Reverse Voltage , $V_{_{\rm R}}[V]$ Figure 4. Typical Reverse Recovery Time vs. di/dt Figure 3. Typical Junction Capacitance 16 ₹ I_F = 20A - (NA) 25 Reverse Recovery Current , $\frac{1}{1}$ [A] $\frac{1}{1}$ [A] $\frac{1}{1}$ [A] $\frac{1}{1}$ $\frac{1}{1}$ $T_{\rm C} = 25^{\circ}{\rm C}$ Current 120 S Forward Average 0 └─ 100 0 L 60 di/dt [A/μs] Case Temperature, T_c[°C]

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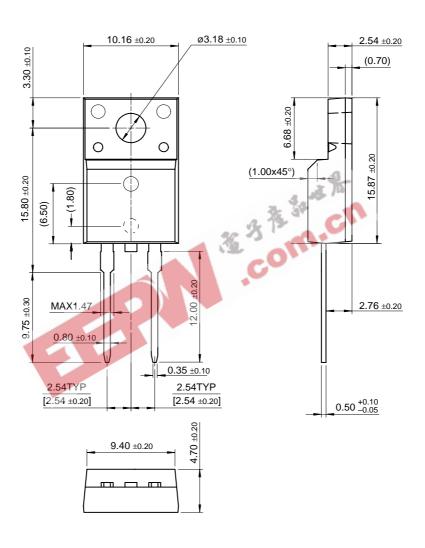
Figure 6. Forward Current Derating Curve

Figure 5. Typical Reverse Recovery Current

vs. di/dt

Package Dimensions

TO-220F 2L



Dimensions in Millimeters

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